



**P-Channel Enhancement-Mode Vertical DMOS Power FETs**

**Ordering Information**

BV <sub>DSS</sub> / BV <sub>DGS</sub>	R <sub>DS(ON)</sub> (max)	I <sub>D(ON)</sub> (min)	Order Number / Package		
			TO-39	TO-92	TO-220
-160V	16Ω	0.75A	VP0216N2	VP0216N3	VP0216N5
-200V	16Ω	0.75A	VP0220N2	VP0220N3	VP0220N5

**Features**

- Freedom from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>iss</sub> and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

**Advanced DMOS Technology**

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

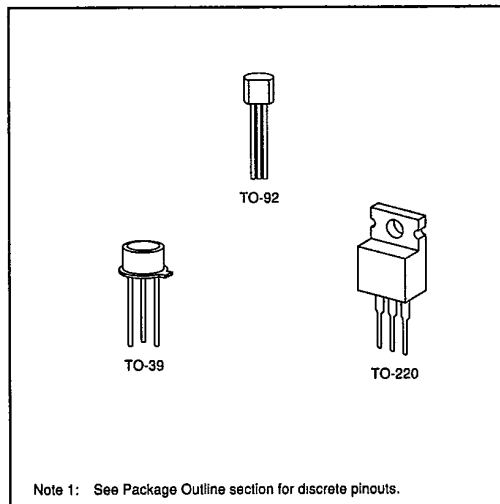
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

**Applications**

- Motor control
- Convertors
- Amplifiers
- Switches
- Power supply circuits
- Driver (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

**Package Options**

(Note 1)



Note 1: See Package Outline section for discrete pinouts.

**Absolute Maximum Ratings**

Drain-to-Source Voltage	BV <sub>DSS</sub>
Drain-to-Gate Voltage	BV <sub>DGS</sub>
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\*Distance of 1.6 mm from case for 10 seconds.

7-39-19

VP02C

**Thermal Characteristics**

Package	I <sub>D</sub> (continuous)*	I <sub>D</sub> (pulsed)*	Power Dissipation @ T <sub>C</sub> = 25°C	θ <sub>Jc</sub> °C/W	θ <sub>Ja</sub> °C/W	I <sub>DR</sub>	I <sub>DRM</sub> *
TO-39	-0.35A	-1.0A	4W	32	125	-0.35A	-1.0A
TO-92	-0.2A	-1.0A	1W	125	170	-0.2A	-1.0A
TO-220	-0.8A	-2.5A	27W	4.7	70	-0.8A	-2.5A

\* I<sub>D</sub> (continuous) is limited by max rated T<sub>J</sub>

**Electrical Characteristics (@ 25°C unless otherwise specified)**

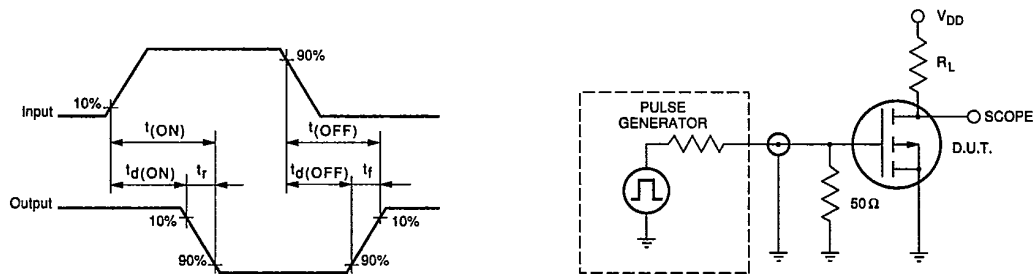
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	VP0220	-200		V	V <sub>GS</sub> = 0, I <sub>D</sub> = -2.5mA
		VP0216	-160			
V <sub>GS(th)</sub>	Gate Threshold Voltage	-1.0		-3.5	V	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -2.5mA
ΔV <sub>GS(th)</sub>	Change in V <sub>GS(th)</sub> with Temperature		-4.5	-6.0	mV/°C	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -2.5mA
I <sub>GSS</sub>	Gate Body Leakage			-100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			-25	μA	V <sub>GS</sub> = 0, V <sub>DS</sub> = Max Rating
				-2	mA	V <sub>GS</sub> = 0, V <sub>DS</sub> = 0.8 Max Rating T <sub>A</sub> = 125°C
I <sub>D(ON)</sub>	ON-State Drain Current	-0.25	-0.4		A	V <sub>GS</sub> = -5V, V <sub>DS</sub> = -25V
		-0.75	-0.85			V <sub>GS</sub> = -10V, V <sub>DS</sub> = -25V
R <sub>DS(ON)</sub>	Static Drain-to-Source ON-State Resistance		9	16	Ω	V <sub>GS</sub> = -5V, I <sub>D</sub> = -0.1A
			7	16		V <sub>GS</sub> = -10V, I <sub>D</sub> = -0.25A
ΔR <sub>DS(ON)</sub>	Change in R <sub>DS(ON)</sub> with Temperature		0.5	1.2	%/°C	V <sub>GS</sub> = -10V, I <sub>D</sub> = -0.25A
G <sub>FS</sub>	Forward Transconductance	0.1	0.2		∅	V <sub>DS</sub> = -25V, I <sub>D</sub> = -0.25A
C <sub>ISS</sub>	Input Capacitance		85	150	pF	V <sub>GS</sub> = 0, V <sub>DS</sub> = -25V f = 1 MHz
C <sub>OSS</sub>	Common Source Output Capacitance		60	85		
C <sub>RSS</sub>	Reverse Transfer Capacitance		10	35		
t <sub>d(ON)</sub>	Turn-ON Delay Time		8	10	ns	V <sub>DD</sub> = -25V I <sub>D</sub> = -1.0A R <sub>S</sub> = 50Ω
t <sub>r</sub>	Rise Time		10	15		
t <sub>d(OFF)</sub>	Turn-OFF Delay Time		15	20		
t <sub>f</sub>	Fall Time		10	15		
V <sub>SD</sub>	Diode Forward Voltage Drop		-1.2	-1.8		
t <sub>rr</sub>	Reverse Recovery Time		400		ns	V <sub>GS</sub> = 0, I <sub>SD</sub> = -0.5A

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)

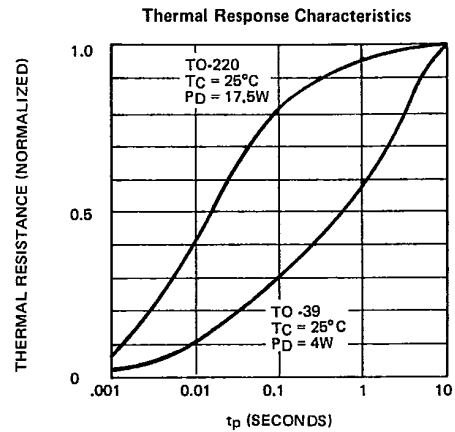
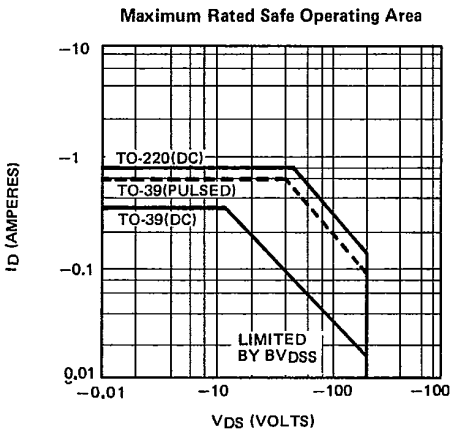
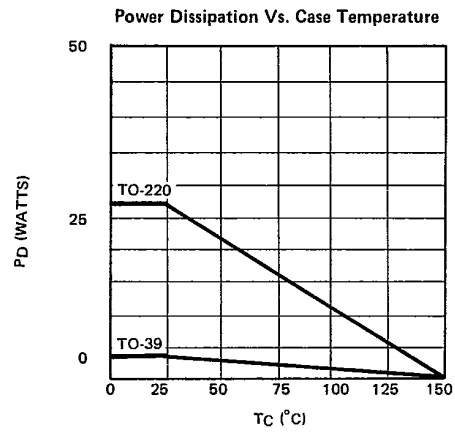
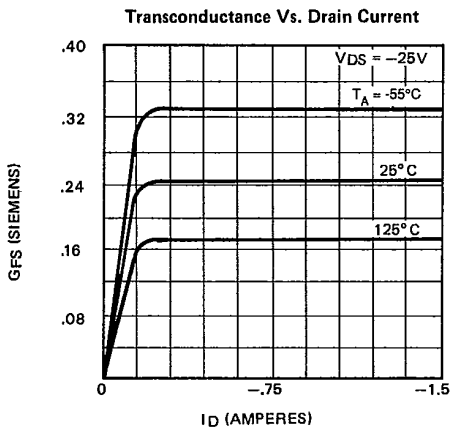
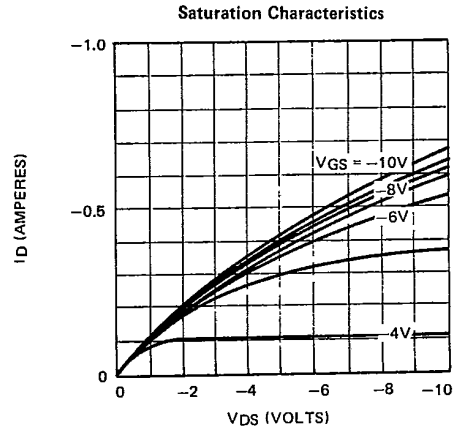
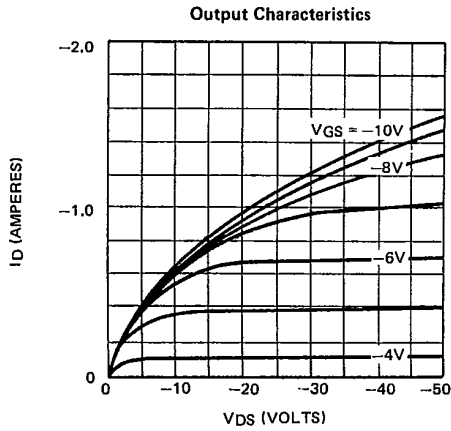
Note 2: All A.C. parameters sample tested.

**Switching Waveforms and Test Circuit**



Typical Performance Curves

T-39-19



9

T-39-19

